



RENAFAE Workshop 2021

Development of GEMs and its technological applications

An overview of the research done at HEPIC-USP and perspectives

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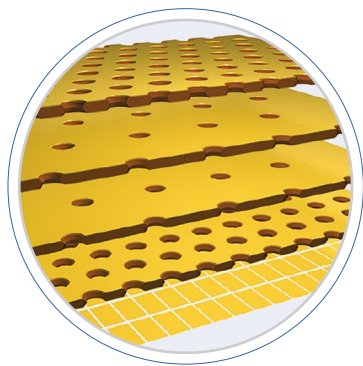
Gustavo Ferraz Trindade, Yinfeng He, Jisun Im, Clive Roberts, Richard Hague

University of Nottingham

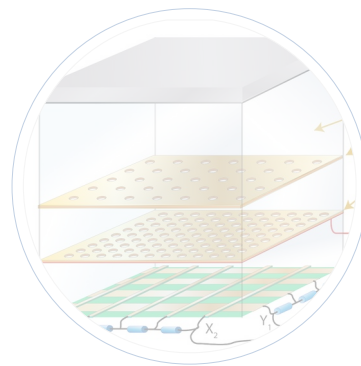
Rob Veenhof

CERN

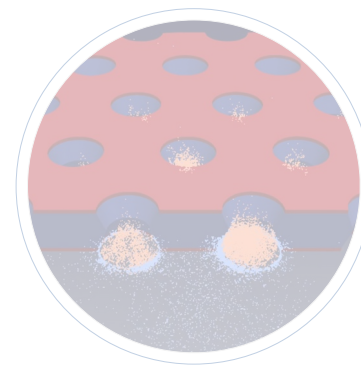
- **Support** the GEM based **ALICE-TPC** during Run 3
 - *Aging and degradation*
 - *Sanity check and monitoring*
- Develop a **fully functional prototype** of a GEM based radiation detector aiming applications in science and technology
 - *Energy and position sensitivity*
 - *Develop local expertise*
 - *Sensor and data acquisition system*
- **Research under the RD51 collaboration**



Introduction

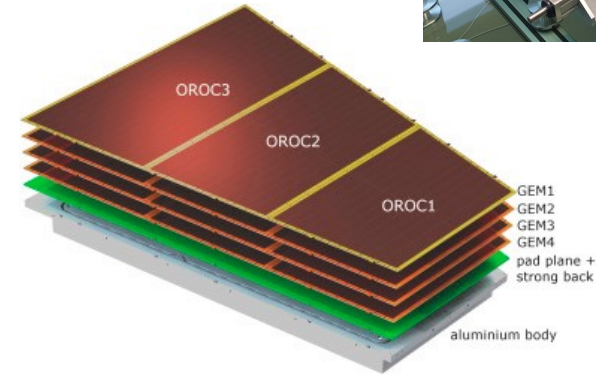
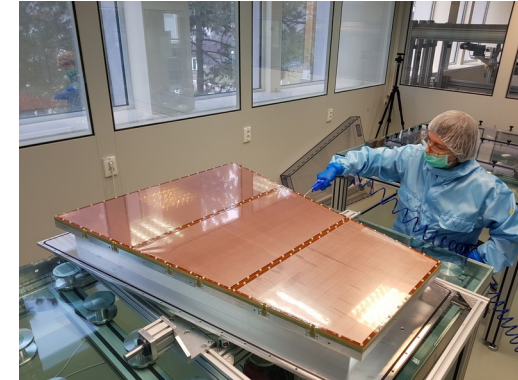
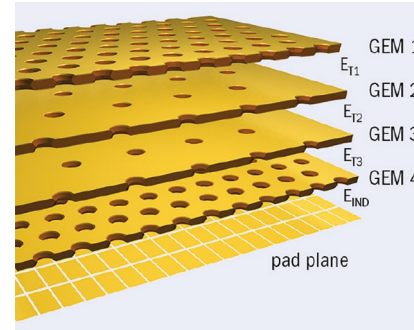
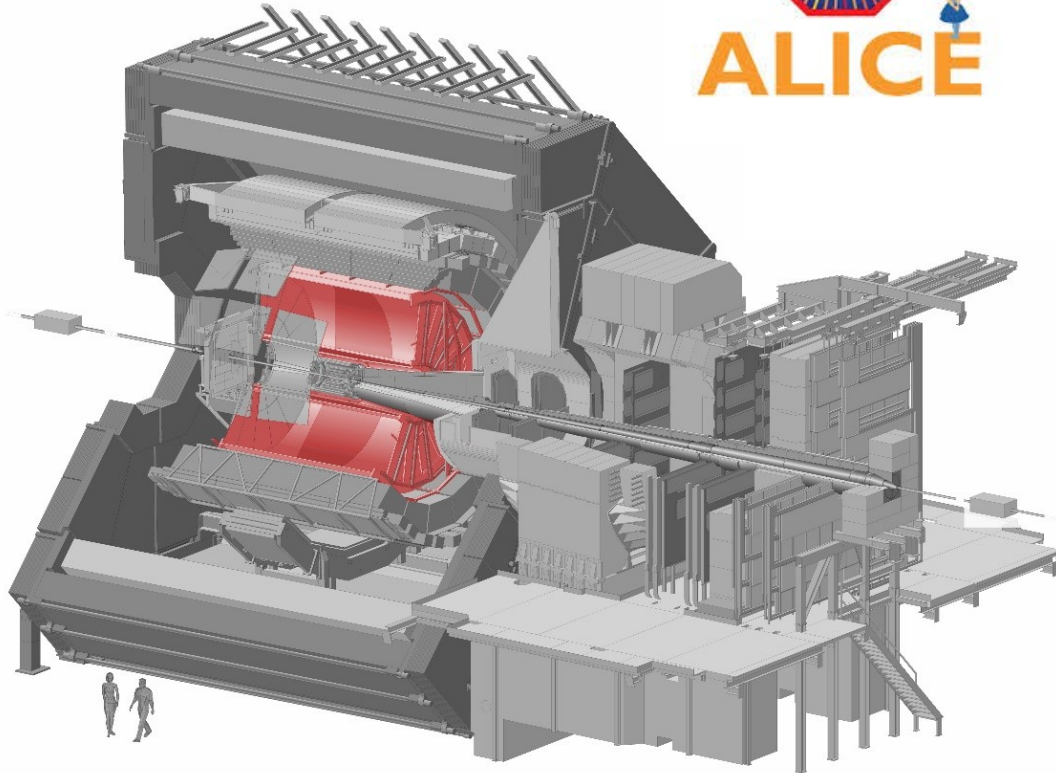


Applications

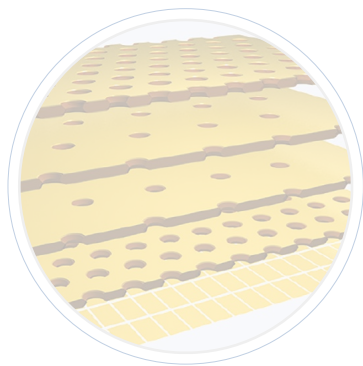


Developments

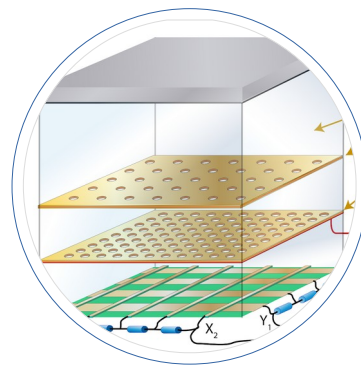
ALICE-TPC upgrade for the Run 3



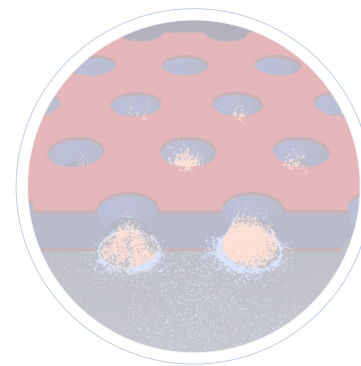
P. Gasik, Nucl. Instr. and Meth. A, v. 845, 222-225, 2017,



Introduction



Applications

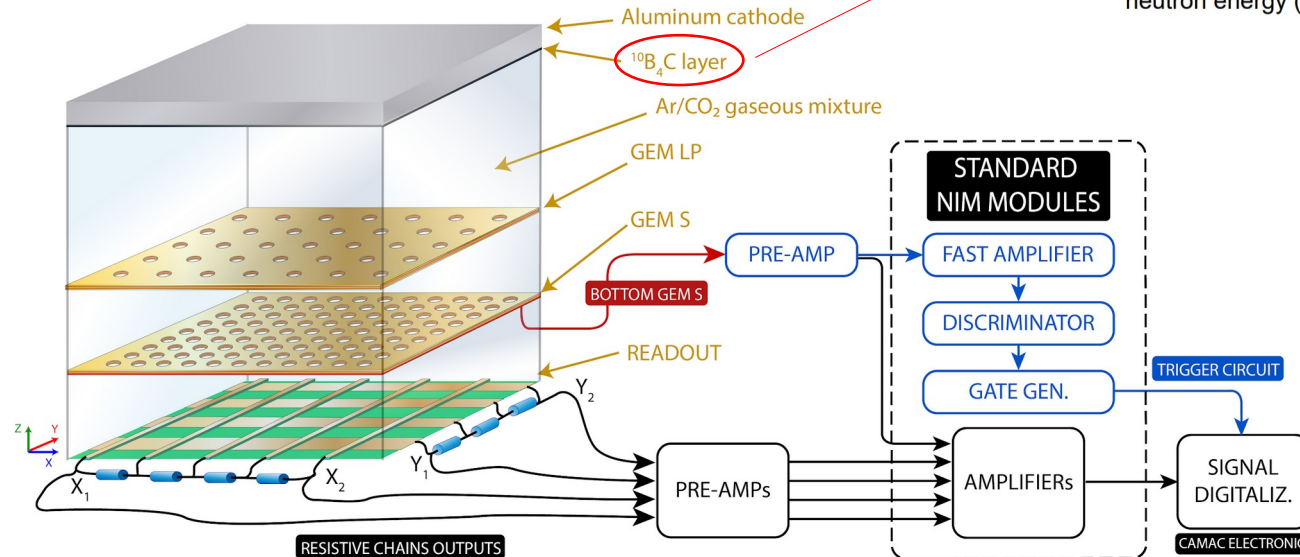
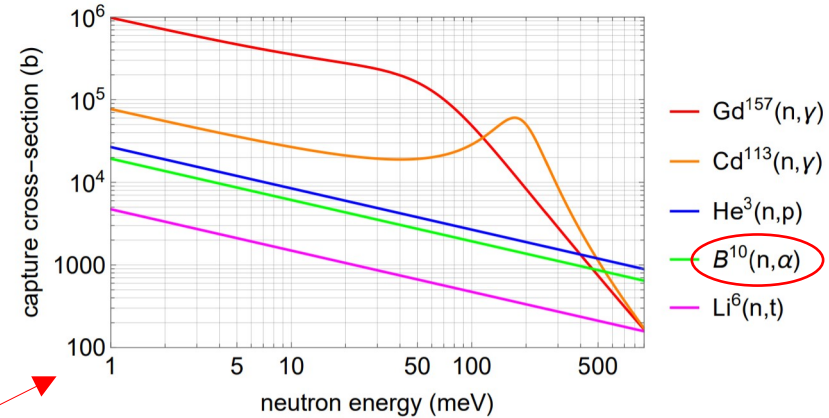


Developments

Neutron detection with imaging capabilities

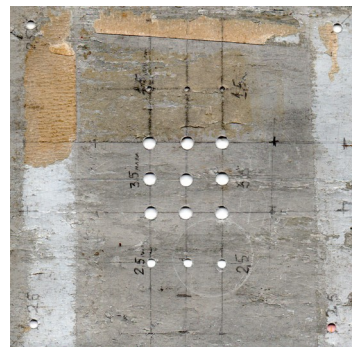
Neutron detector schematics

- Enabling GEM sensitivity to neutrons by a conversion layer
- Boron carbide to neutron absorption with emission of alpha and lithium ion (both ionize the gas)

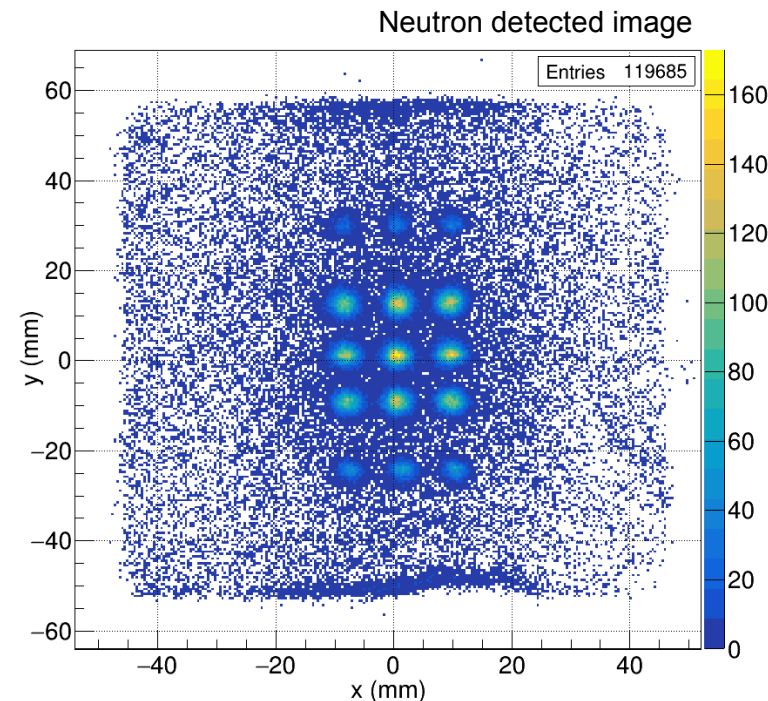


Deep understanding of the physical model

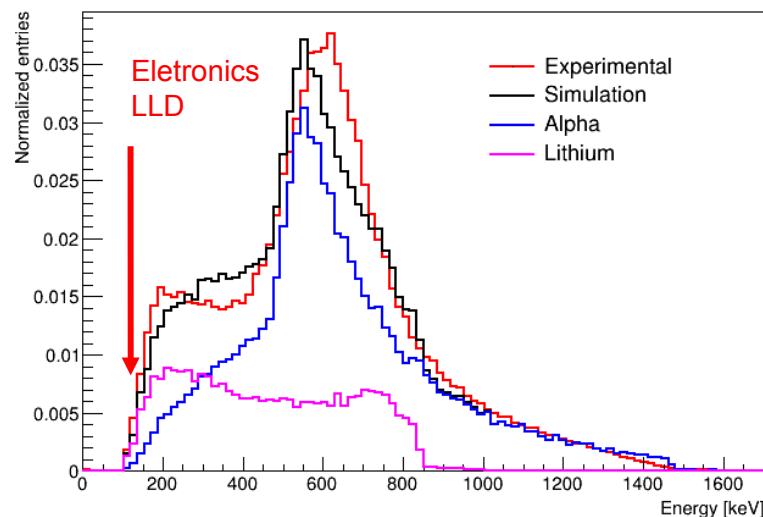
- Good agreement between experimental observation and Geant4 simulations.



Cadmium absorber (mask)



Neutron detected image

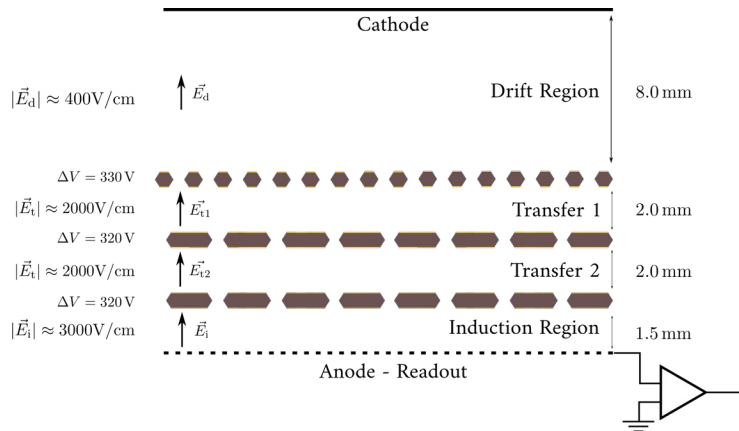
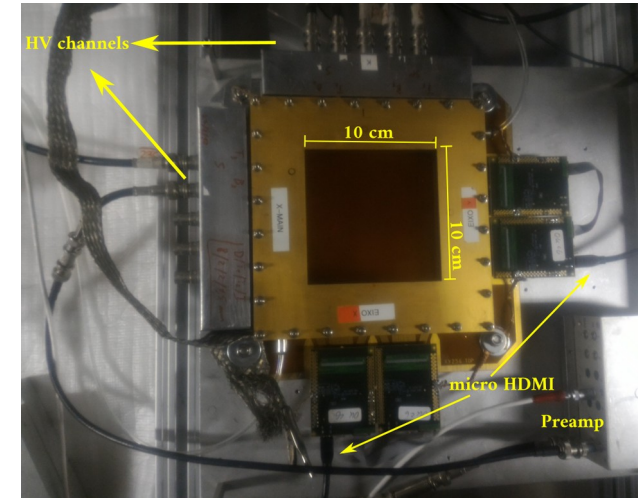


Observed image resolution of **2.71(7) mm**

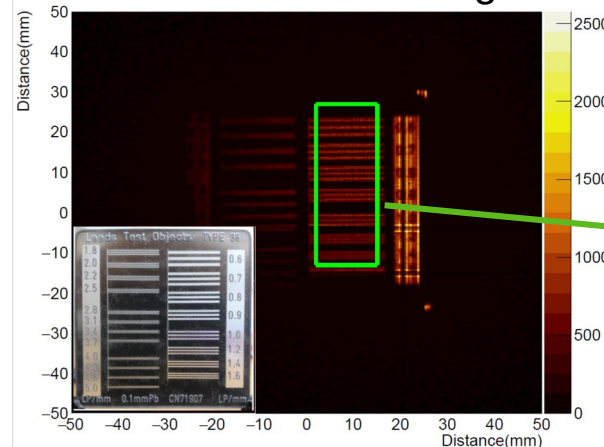
Predicted efficiency using Geant4 simulations: **3.14(4)%**
Efficiency obtained experimentally: **2.66(30)%**

Images in transmission mode

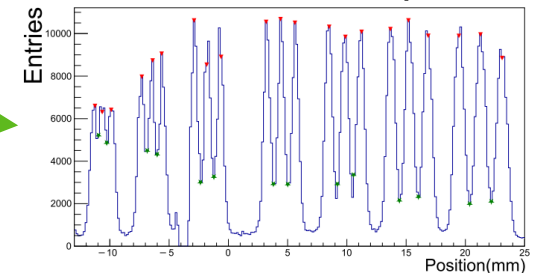
- Triple-GEM with strip read-out (256 strips for each dimension)
- 100 cm² active area
- Operating with Ar/CO₂ (70/30) at atmospheric pressure
- Gain of the order of 10⁴
- Acquisition rate \approx 1.2kHz



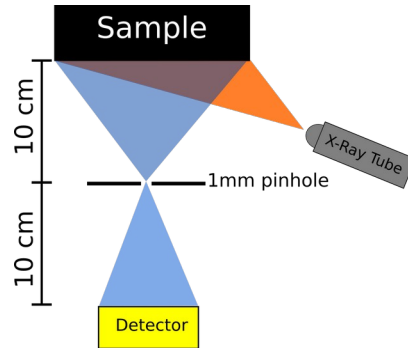
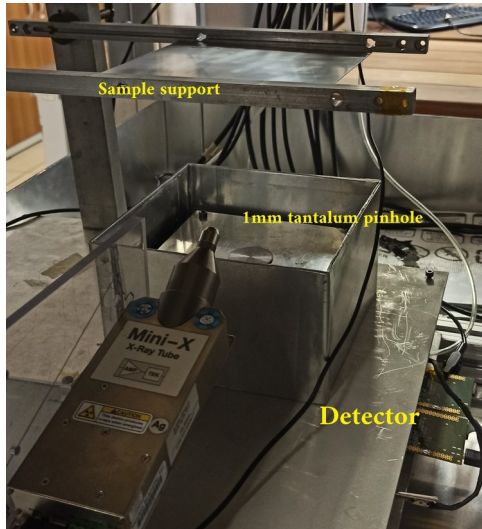
Resolution mask image



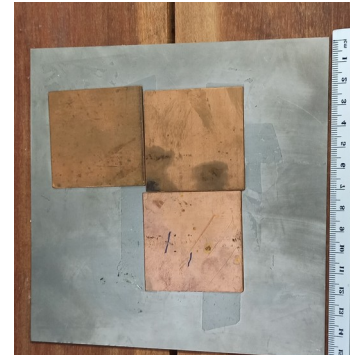
Resolution mask profile



Images in fluorescence mode

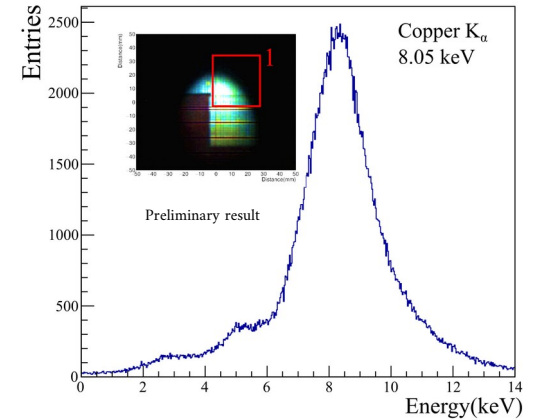


Test sample of a titanium plate with copper sectors

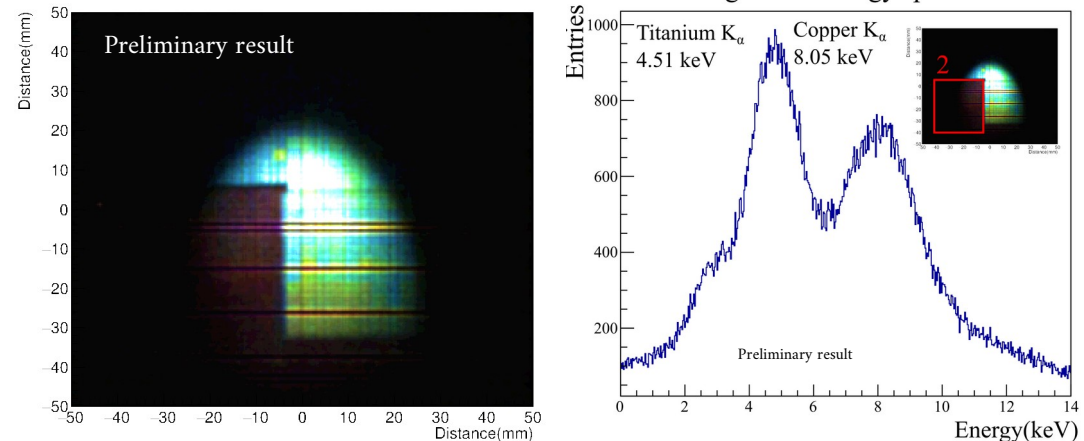


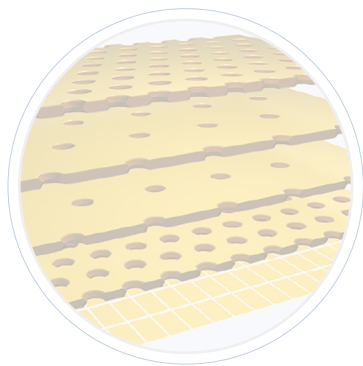
- Detector field of view limited by a 1 mm tantalum pinhole enabling near field images
- Acquisition rate $\approx 250\text{Hz}$

Region 1 - Energy spectrum

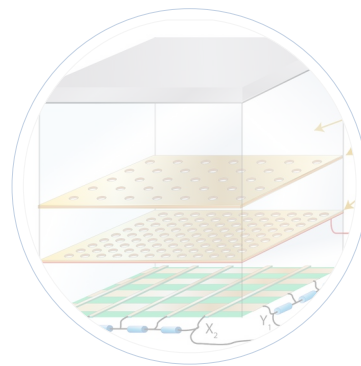


Region 2 - Energy spectrum

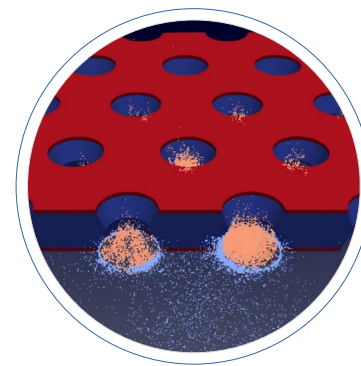




Introduction



Applications



Developments

Electronics and data acquisition: the SAMPA chip

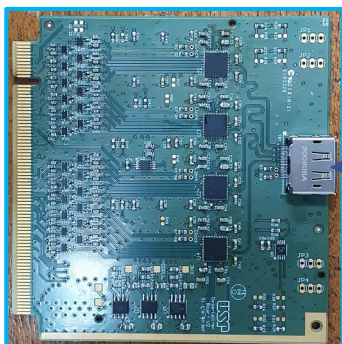
- A new ASIC for the readout of gaseous detector of high energy experiments (ALICE @LHC [CERN], STAR and sPHENIX @ RHIC [EUA], MPD @NICA [Russia])
- Developed in São Paulo by LSI, Escola Politécnica (design) and local HEPIC group (validation)

Specs

- TSMC CMOS 130 nm, 1.25V technology
- 32 channels, Front-end + ADC + DSP
- package size $\leq 15 \times 15 \text{mm}^2$ (total footprint)
- ADC: 10-bit resolution, 10MS/s, ENOB > 9.2
- DSP functions: pedestal removal, baseline shift corrections, zero-suppression
- Data transmission: up to 11 e-link at 320 Mbps to GBTx, SLVS I/O
- Power < 32 mW/channel (FrontEnd+ADC)

- Already in operation @STAR and @ALICE, more developments for sPHENIX and studies ongoing to wide even more its possible applications:

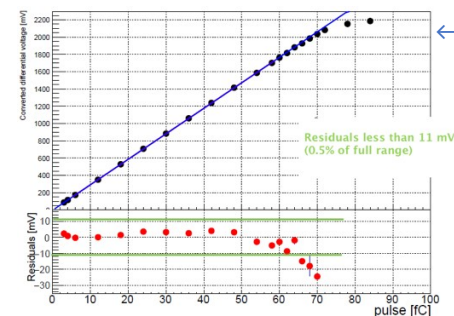
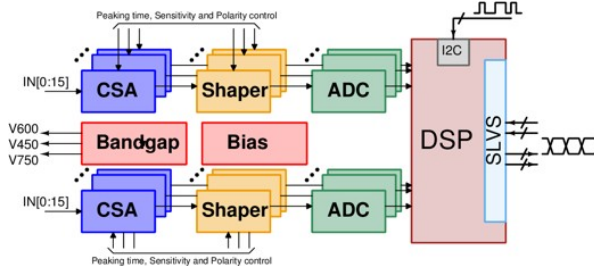
Porting the SAMPA in the Scalable Readout-System (SRS), a standard in the RD51 community



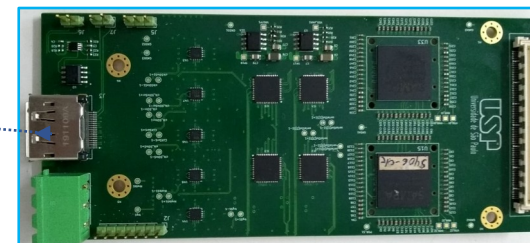
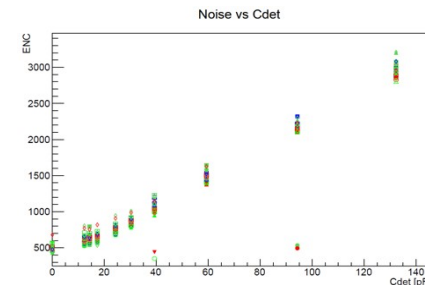
← SAMPA-SRS Interface board
Interface board to the SRS FEC.
Contains the demultiplexer

← Display port cable →
A DP cable, 5 data links (4 SAMPAs + clock&controls), used to connect the hybrid and crate electronics

SAMPA-SRS Hybrid →
Hybrid with 4 SAMPAs, readying 128 channels.
Each SAMPA has a devoted multiplexer to send out 4 e-links via one higher speed data link



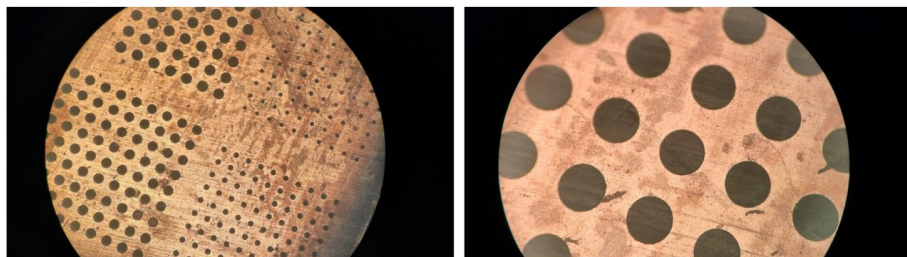
Low Noise →
Tuned to be below 650 ENC at ~18pF



Collaboration with LSI-POLI

First results with optical lithography and chemical etching

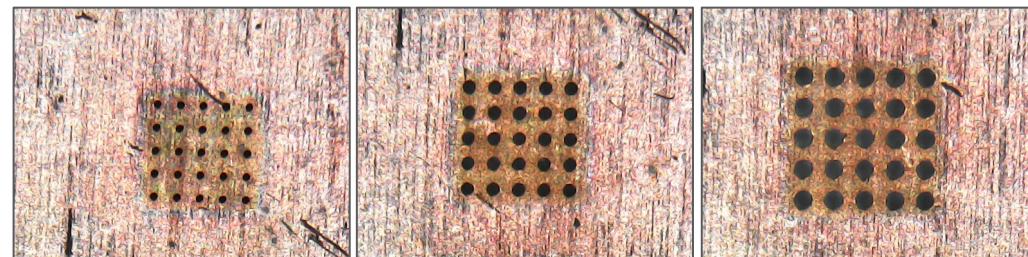
- Copper film micro-patterned



Method: Laser cut

Why? - New, clean (free of KOH) and fast

When? - Equipment maintenance



21 μm

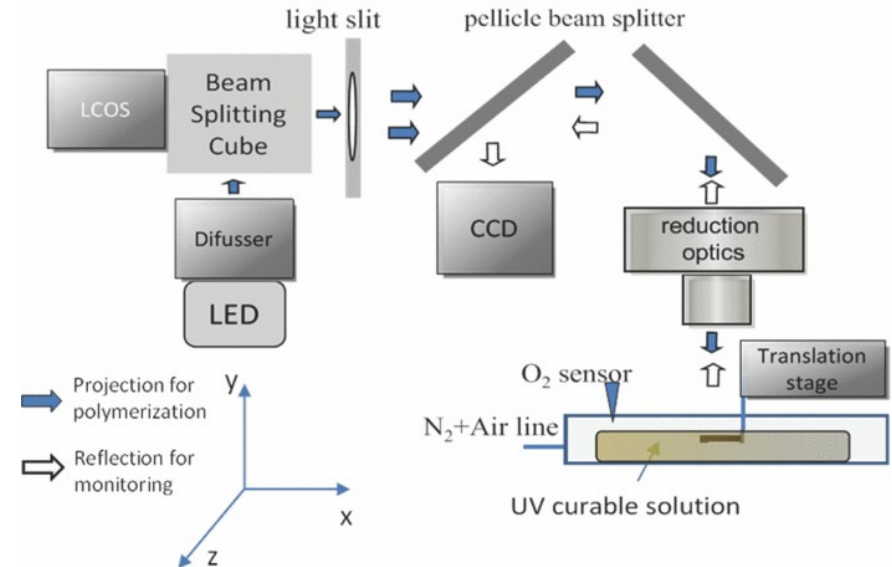
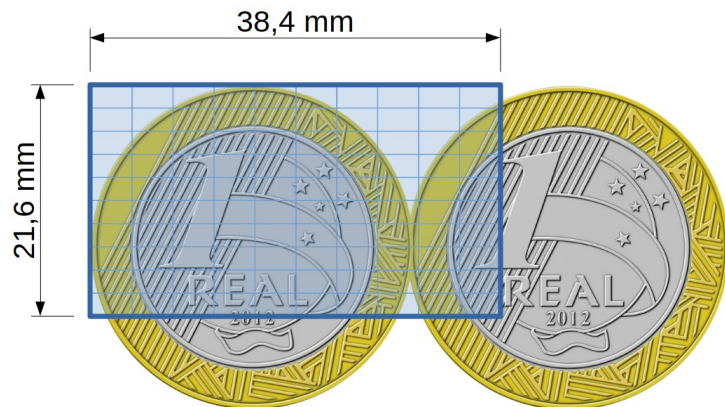
35 μm

49 μm

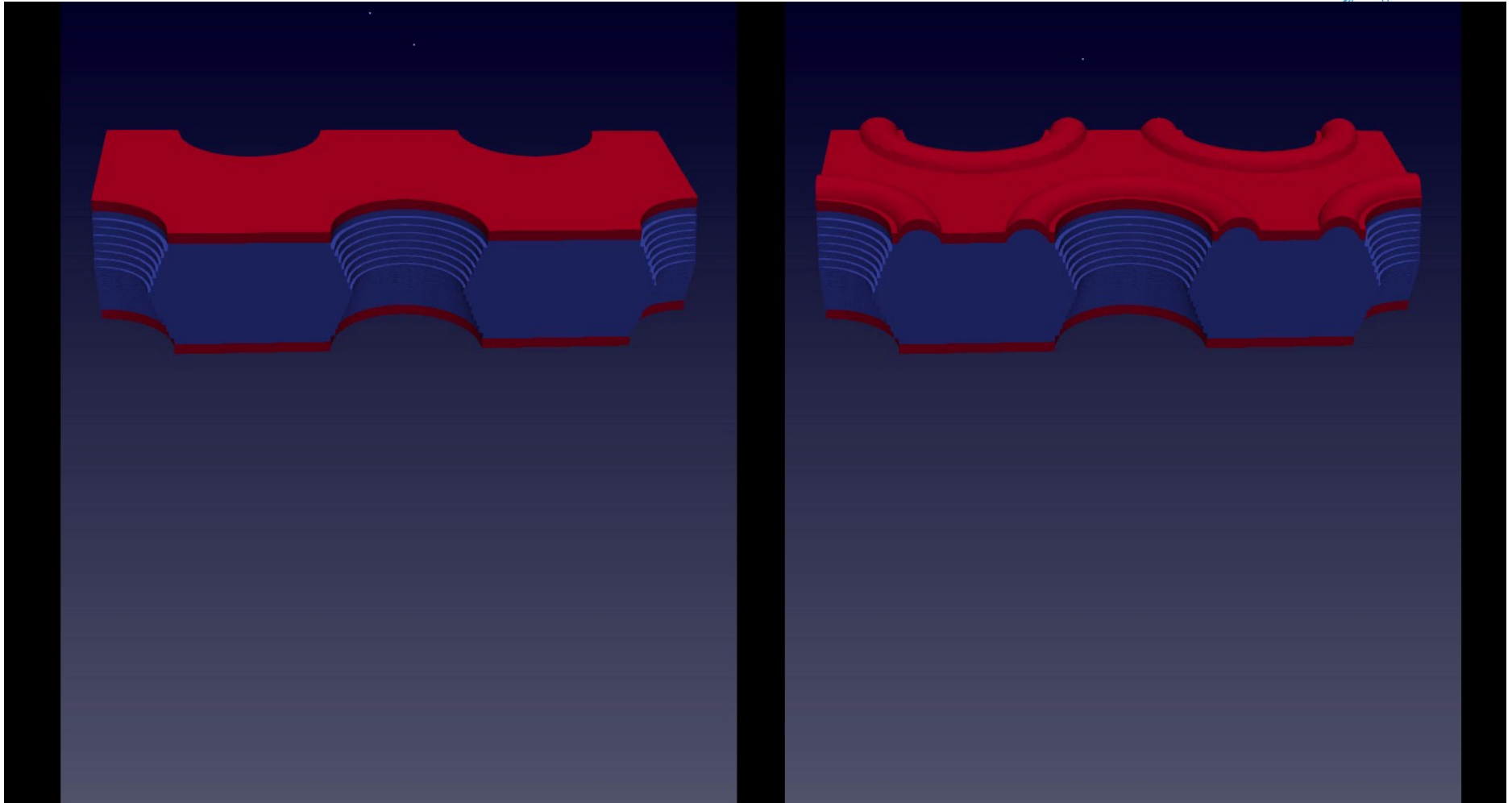
Micrometer resolution 3D printing

Enabling flexibility and speed to prototyping

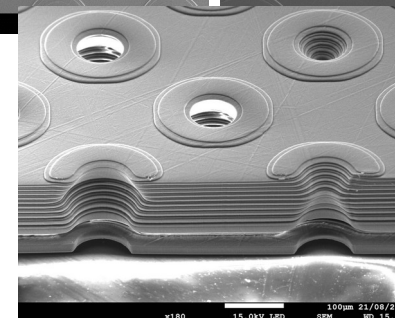
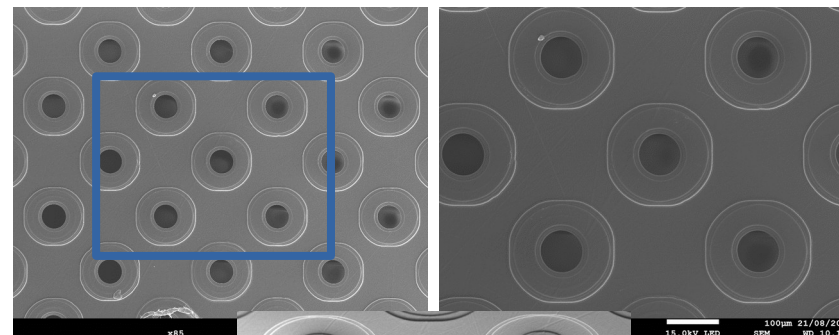
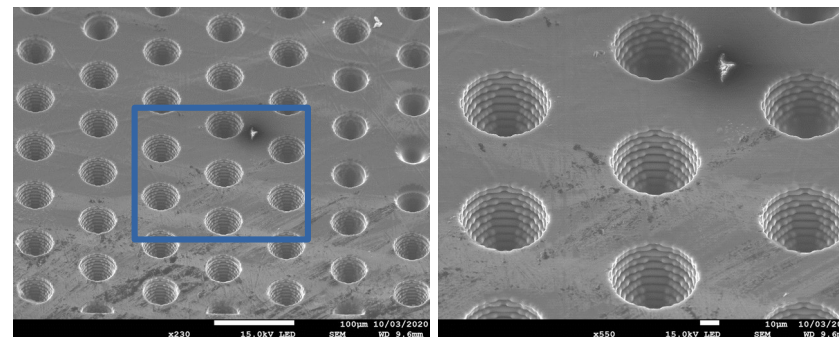
- Projection micro stereolithography (collaboration with BMF3D):
 - Printing voxel resolution: 2-3 μm
 - Single exposure size: 3.84 mm (X) * 2.16 mm (Y) * 10 mm (Z)
 - Maximum product size: 38.4mm (X) * 21.6mm (Y) * 10 mm (Z)



Zheng, X., Deotte, J., Alonso, M.P., Farquar, G.R., Weisgraber, T.H., Gemberling, S., Lee, H., Fang, N. and Spadaccini, C.M., 2012. Design and optimization of a light-emitting diode projection micro-stereolithography three-dimensional manufacturing system. *Review of Scientific Instruments*, 83(12), p.125001. [link]

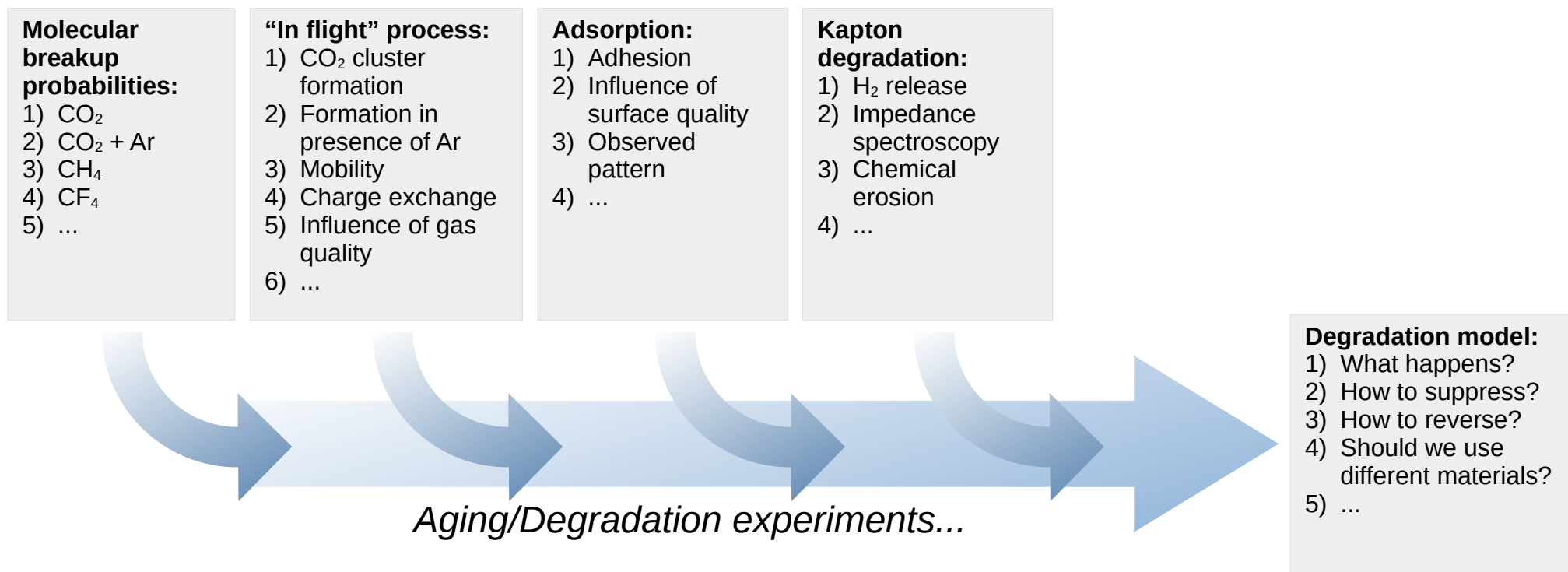


- Tests of spatial resolution
- Hexagonal matrix of holes in dielectric material
 - Holes with 50 μm diameter
- Material HDDA based polymer
- Conclusions:
 - Consistent along the foil
 - Very reproducible
 - Flexibility of geometry

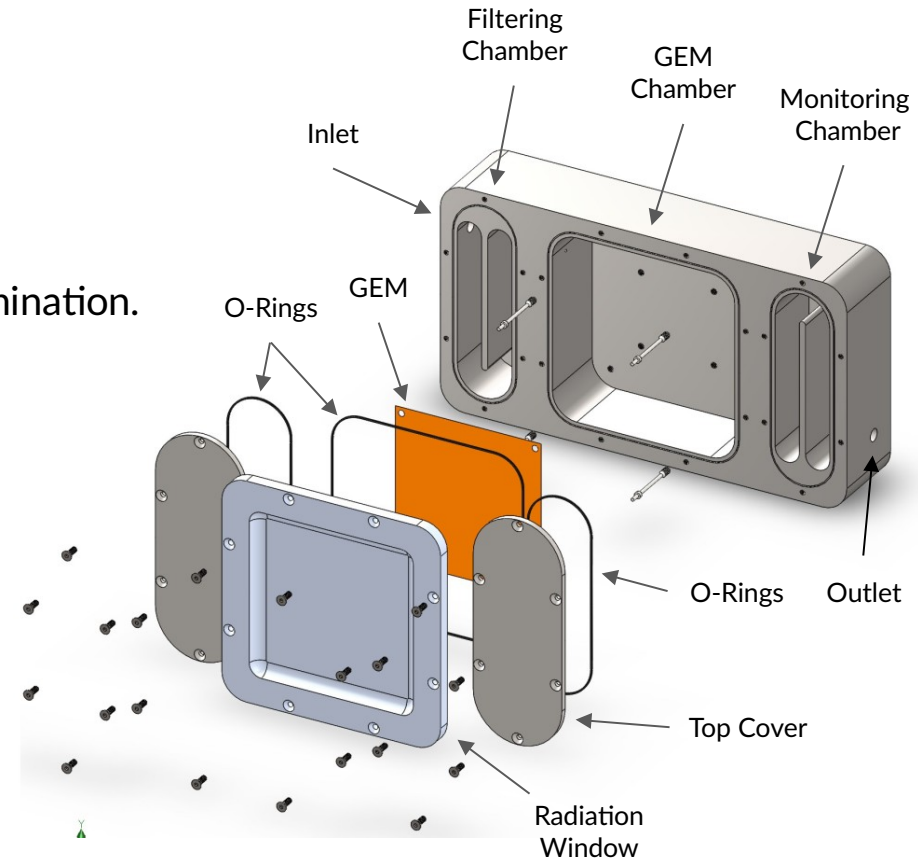


The study of aging and degradation processes enable:

- Optimization for technological applications
- Contribution to the understanding of the GEM aging of the ALICE-TPC



- **Stainless steel chamber**
 - Clean ambient and avoid degassing.
- **Inlet/Filtering Chamber**
 - Filled with purifying materials.
 - Removal of eventual H_2O and O_2 contamination.
- **Outlet/Monitoring chamber**
 - Environmental sensors:
 - Temperature and pressure.
 - Gas quality monitoring:
 - H_2O , O_2 and H_2 .
- **Both attached to the GEM chamber**
 - To avoid tubes.



- Applications
 - Readouts (purchase or new design?)
 - Electronics based on SAMPA chip [Cost estimate in progress]
- Local production
 - Lithography and etching or laser cutting? [Cost estimate in progress]
 - Support to the 3D printing project [Supplies and services]
- Aging and degradation
 - Expenses on analysis [Cost estimate in progress]
 - Sensor to the controlled experiments [~U\$20k]
 - Gas analysis in the outlet (mass spectrometer) [~U\$60k]
 - Dielectric Relaxation Spectroscopy (sanity check of GEM foils) [~U\$100k]

- **Possible funding:**
 - FAPESP and CNPq are already supporting projects
- **Possible spin-offs:**
 - X-ray detector with energy and position sensitivity
 - *Dosimetry and medical physics*
 - *Security and quality control*
 - *Síruis@LNLS?*
 - Neutron detector with position sensitivity
 - *Nuclear reactors like RMB and IPEN*
 - Others:
 - *Diagnostics in fusion reactors*